

UNIT 79.064APC

IFW 1714
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Tomohide BANBA et al.
Appl. No. : 10/565,565
Filed : January 23, 2006
For : AN INORGANIC POWDER-
CONTAINING RESIN COMPOSITION,
A FILM-FORMING MATERIAL
LAYER, A TRANSFER SHEET,
METHOD OF PRODUCING A
SUBSTRATE HAVING A DIELECTRIC
LAYER FORMED THEREON, AND A
SUBSTRATE HAVING A DIELECTRIC
LAYER FORMED THEREON
Examiner : SZEKELY, Peter A.
Art Unit : 1714

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Office of Initial Patent Examination, Customer Service Center, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

August 9, 2006

(Date)


Kerry Taylor, Reg. No. 43,947

REQUEST FOR CORRECTED FILING RECEIPT

Office of Initial Patent Examination
Customer Service Center
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:


Applicants hereby request that the Official Filing Receipt, a copy of which is enclosed, be corrected to reflect the true title of the invention, AN INORGANIC POWDER-CONTAINING RESIN COMPOSITION, A FILM-FORMING MATERIAL LAYER, A TRANSFER SHEET, METHOD OF PRODUCING A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON, AND A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON, and true name of the eighth inventor, MITSUHIRO KANADA. Presently, the Filing Receipt incorrectly shows the title as INORGANIC POWDER-CONTAINING RESIN COMPOSITION, FILM-FORMING MATERIAL LAYER, TRANSFER SHEET, METHOD FOR PRODUCING

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SUBSTRATE WITH DIELECTRIC LAYER, AND SUBSTRATE WITH DIELECTRIC LAYER, and the inventor's name as MITSUHIRO KANADA.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 9 August 2006 By: 
Kerry Taylor
Registration No. 43,947
Attorney of Record
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2821863/ck/080906



UNITED STATES PATENT AND TRADEMARK OFFICE

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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/565,565	01/23/2006	1714	900	UNI079.064APC		18	2

CONFIRMATION NO. 2113

20995
KNOBBE MARTENS OLSON & BEAR LLP
2040 MAIN STREET
FOURTEENTH FLOOR
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FILING RECEIPT



OC000000019064116

Date Mailed: 06/06/2006

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Tomohide Banba, Osaka, JAPAN;
Katsuya Kume, Osaka, JAPAN;
Makoto Kai, Osaka, JAPAN;
Natsuki Kobayashi, Osaka, JAPAN;
Mami Ikeya, Osaka, JAPAN;
Yasushi Buzoujima, Osaka, JAPAN;
Junichi Sekiya, Osaka, JAPAN;
~~Mitsuhiko~~ Kanada, Osaka, JAPAN;

Mitsuhiko

Power of Attorney: The patent practitioners associated with Customer Number 20995.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/10483 07/23/2004

Foreign Applications

JAPAN 2003-279206 07/24/2003

If Required, Foreign Filing License Granted: 06/01/2006

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is **US10/565,565**

Projected Publication Date: 09/07/2006

Non-Publication Request: No

Early Publication Request: No**Title**

AN INORGANIC POWDER-CONTAINING RESIN COMPOSITION, A FILM-FORMING MATERIAL LAYER, A TRANSFER SHEET, METHOD OF PRODUCING A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON, AND A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON

~~Inorganic powder-containing resin composition, film-forming material layer, transfer sheet, method for producing substrate with dielectric layer, and substrate with dielectric layer.~~

Preliminary Class

524

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

Applicants also are advised that in the case of inventions made in the United States, the Director of the USPTO must issue a license before applicants can apply for a patent in a foreign country. The filing of a U.S. patent application serves as a request for a foreign filing license. The application's filing receipt contains further information and guidance as to the status of applicant's license for foreign filing.

Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at <http://www.uspto.gov/web/offices/pac/doc/general/index.html>.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, <http://www.stopfakes.gov>. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

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DECLARATION - USA PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am an original, first and joint inventor of the subject matter which is claimed

and for which a patent is sought on the invention entitled
**AN INORGANIC POWDER-CONTAINING RESIN COMPOSITION, A FILM-FORMING
MATERIAL LAYER, A TRANSFER SHEET, METHOD OF PRODUCING A SUBSTRATE
HAVING A DIELECTRIC LAYER FORMED THEREON, AND A SUBSTRATE HAVING A
DIELECTRIC LAYER FORMED THEREON**

PCT Application No. PCT/JP2004/010483 filed in the Japanese Receiving Office on July 23, 2004; the documentation for entry into the U.S. national phase of which is attached hereto;

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

PRIOR FOREIGN APPLICATION(S)

No.: 2003-279206

Country: Japan

Date Filed: 24/07/03

Priority
Claimed
Yes

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first inventor: Tomohide BANBA

Inventor's signature Tomohide Banba

Date November 1, 2005

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Inventor's signature Katsuya Kume

Date November 1, 2005

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Full name of third inventor: Makoto KAI

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Full name of forth inventor: Natsuki KOBAYASHI

Inventor's signature Natsuki Kobayashi

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Full name of fifth inventor: Mami IKEYA

Inventor's signature Mami Ikeya

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Full name of sixth inventor: Yasushi BUZOUJIMA

Inventor's signature Yasushi Buzoujima

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Full name of seventh inventor: Junichi SEKIYA

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Date November 1, 2005

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Full name of eighth inventor: Mitsuhiro KANADA

Inventor's signature Mitsuhiro Kanada

Date November 1, 2005

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